**Vishay Semiconductors** 

# "Half Bridge" IGBT MTP (Warp Speed IGBT), 114 A



PRODUCT SUMMARY						
V <sub>CES</sub>	600 V					
$V_{CE(on)}$ typical at $V_{GE}$ = 15 V	2.3 V					
I <sub>C</sub> at T <sub>C</sub> = 25 °C	114 A					
Package	MTP					
Circuit	Half bridge					

### **FEATURES**

- Generation 4 warp speed IGBT technology
- HEXFRED® antiparallel diodes with ultrasoft reverse recovery
- Very low conduction and switching losses
- Optional SMD thermistor (NTC)
- · Very low junction to case thermal resistance
- UL approved file E78996
- Speed 60 kHz to 100 kHz
- · Designed and qualified for industrial level
- · Material categorization: For definitions of compliance please see www.vishay.com/doc?99912

#### BENEFITS

- Optimized for welding, UPS and SMPS applications
- · Low EMI, requires less snubbing
- Direct mounting to heatsink
- PCB solderable terminals
- · Very low stray inductance design for high speed operation

ABSOLUTE MAXIMUM RATINGS							
PARAMETER	SYMBOL	TEST CONDITIONS	MAX.	UNITS			
Collector to emitter voltage	V <sub>CES</sub>		600	V			
Continuous collector current		T <sub>C</sub> = 25 °C	114				
Continuous collector current	I <sub>C</sub>	T <sub>C</sub> = 109 °C	50				
Pulsed collector current	I <sub>CM</sub>		350				
Peak switching current	I <sub>LM</sub>		350	A			
Diode continuous forward current	١ <sub>F</sub>	T <sub>C</sub> = 109 °C	34				
Peak diode forward current	I <sub>FM</sub>		200				
Gate to emitter voltage	V <sub>GE</sub>		± 20	V			
RMS isolation voltage	V <sub>ISOL</sub>	Any terminal to case, t = 1 min	2500	V			
Maximum nower dissinction	Р	T <sub>C</sub> = 25 °C	658	W			
Maximum power dissipation	PD	T <sub>C</sub> = 100 °C	263	VV			



COMPLIANT



## VS-50MT060WHTAPbF



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<b>ELECTRICAL SPECIFICATIONS</b> ( $T_J = 25 \text{ °C}$ unless otherwise specified)								
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS		
Collector to emitter breakdown voltage	V <sub>(BR)CES</sub>	$V_{GE}$ = 0 V, I <sub>C</sub> = 500 µA	600	-	-	V		
		$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 50 \text{ A}$	-	2.3	3.15			
Collector to emitter voltage	V <sub>CE(on)</sub>	$V_{GE} = 15 \text{ V}, \text{ I}_{C} = 100 \text{ A}$	-	2.5	3.2	V		
		$V_{GE}$ = 15 V, $I_C$ = 50 A, $T_J$ = 150 $^\circ C$	-	1.72	2.17			
Gate threshold voltage	V <sub>GE(th)</sub>	$I_{\rm C} = 0.5 \ {\rm mA}$	3	-	6			
		$V_{GE} = 0 \text{ V}, I_{C} = 600 \text{ A}$	-	-	0.4	mA		
Collector to emitter leaking current	I <sub>CES</sub>	$V_{GE}$ = 0 V, $I_{C}$ = 600 A, $T_{J}$ = 150 $^{\circ}C$	-	-	10	ma		
		$I_{F} = 50 \text{ A}, V_{GE} = 0 \text{ V}$	-	1.58	1.80			
Diode forward voltage drop	V <sub>FM</sub>	$I_{F}$ = 50 A, $V_{GE}$ = 0 V, $T_{J}$ = 150 °C	-	1.49	1.68	V		
		$I_F$ = 100 A, $V_{GE}$ = 0 V, $T_J$ = 25 $^\circ C$	-	1.9	2.17			
Gate to emitter leakage current	I <sub>GES</sub>	$V_{GE} = \pm 20 \text{ V}$	-	-	± 250	nA		

SWITCHING CHARACTERISTICS ( $T_J = 25 \text{ °C}$ unless otherwise specified)							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Total gate charge (turn-on)	Qg	I <sub>C</sub> = 52 A	-	331	385		
Gate to emitter charge (turn-on)	Q <sub>ge</sub>	V <sub>CC</sub> = 400 V	-	44	52	nC	
Gate to collector charge (turn-on)	Q <sub>gc</sub>	V <sub>GE</sub> = 15 V	-	133	176		
Turn-on switching loss	E <sub>on</sub>	Internal gate resistors (see electrical diagram)	-	0.26	-		
Turn-off switching loss	E <sub>off</sub>	$I_{C} = 50$ A, $V_{CC} = 480$ V, $V_{GE} = 15$ V, $L = 200 \mu$ H Energy losses include tail and diode reverse	-	1.2	-	mJ	
Total switching loss	E <sub>ts</sub>	recovery, $T_J = 25 \ ^{\circ}C$	-	1.46	-		
Turn-on switching loss	E <sub>on</sub>	Internal gate resistors (see electrical diagram)	-	0.73	-		
Turn-off switching loss	E <sub>off</sub>	$I_{C} = 50$ A, $V_{CC} = 480$ V, $V_{GE} = 15$ V, $L = 200 \mu$ H Energy losses include tail and diode reverse	-	1.66	-	mJ	
Total switching loss	E <sub>ts</sub>	recovery, $T_J = 150$ °C	-	2.39	-		
Input capacitance	C <sub>ies</sub>	V <sub>GE</sub> = 0 V	-	7100	-		
Output capacitance	C <sub>oes</sub>	$V_{CC} = 30 V$	-	510	-	pF	
Reverse transfer capacitance	C <sub>res</sub>	f = 1.0 MHz	-	140	-		
Diode reverse recovery time	t <sub>rr</sub>		-	82	97	ns	
Diode peak reverse current	Irr	V <sub>CC</sub> = 200 V, I <sub>C</sub> = 50 A dl/dt = 200 A/µs	-	8.3	10.6	А	
Diode recovery charge	Q <sub>rr</sub>	a, at = 2007 (µ0	-	340	514	nC	
Diode reverse recovery time	t <sub>rr</sub>	V <sub>CC</sub> = 200 V, I <sub>C</sub> = 50 A	-	137	153	ns	
Diode peak reverse current	I <sub>rr</sub>	dl/dt = 200 A/µs	-	12.7	14.8	А	
Diode recovery charge	Q <sub>rr</sub>	T <sub>J</sub> = 125 °C	-	870	1132	nC	

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THERMISTOR SPECIFICATIONS							
PARAMETER	SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Resistance	R <sub>0</sub> <sup>(1)</sup>	T <sub>0</sub> = 25 °C	-	30	-	kΩ	
Sensitivity index of the thermistor material	β (1)(2)	T <sub>0</sub> = 25 °C T <sub>1</sub> = 85 °C	-	4000	-	к	

Notes

 $^{(1)}$  T<sub>0</sub>, T<sub>1</sub> are thermistor's temperatures

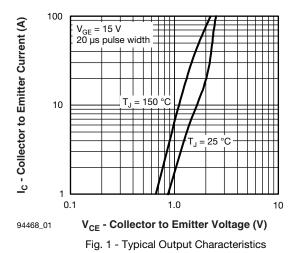
(2)  $\frac{R_0}{R_1} = \exp\left[\beta\left(\frac{1}{T_0} - \frac{1}{T_1}\right)\right]$ , temperature in Kelvin

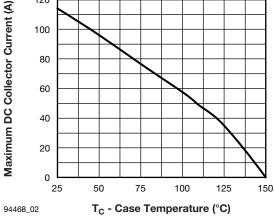
THERMAL AND MECHANICAL SPECIFICATIONS								
PARAMETER		SYMBOL	TEST CONDITIONS	MIN.	TYP.	MAX.	UNITS	
Operating junction	IGBT, Diode	T,I		- 40	-	150		
temperature range	Thermistor	IJ		- 40	-	125	°C	
Storage temperature	range	T <sub>Stg</sub>		- 40	-	125		
IGBT		в		-	-	0.38		
Junction to case Diod	Diode	R <sub>thJC</sub>		-	-	0.8	°C/W	
Case to sink per mod	lule	R <sub>thCS</sub>	Heatsink compound thermal conductivity = 1 W/mK	-	0.06	-		
Clearance <sup>(1)</sup>			External shortest distance in air between 2 terminals	5.5	-	-		
Creepage (1)			Shortest distance along the external surface of the insulating material between 2 terminals	8	-	-	mm	
Mounting torque to heatsink			A mounting compound is recommended and the torque should be checked after 3 hours to allow for the spread of the compound. Lubricated threads.		3 ± 10 %		Nm	
Weight					66		g	

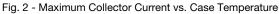
120

#### Note

<sup>(1)</sup> Standard version only i.e. without optional thermistor







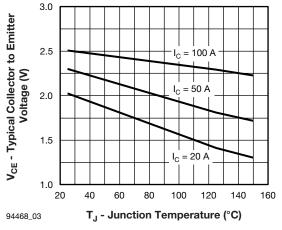
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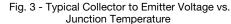
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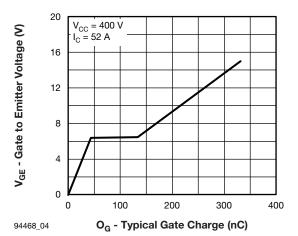
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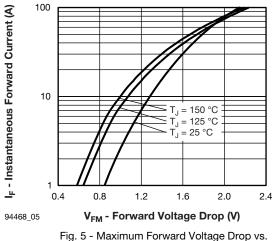








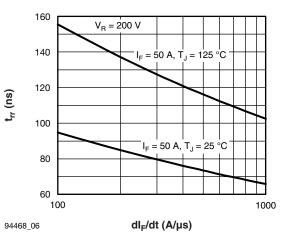




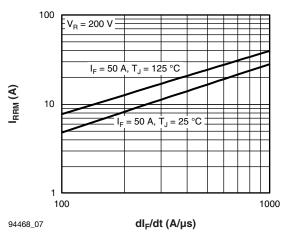
J. 5 - Maximum Forward Voltage Drop V Instantaneous Forward Current

### VS-50MT060WHTAPbF

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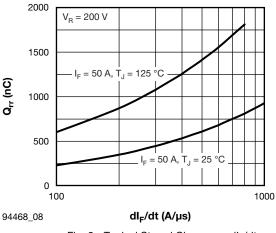
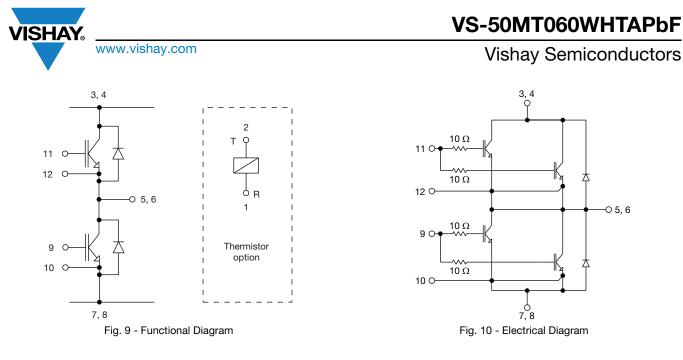


Fig. 8 - Typical Stored Charge vs. dI<sub>F</sub>/dt

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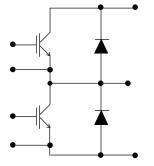


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### **ORDERING INFORMATION TABLE**

Device code	VS-	50	МТ	060	w	н	т	Α	PbF
	1	2	3	4	5	6	7	8	9
	1 -	· \	/ishay S	emicon	ductors	product			
	2 -	C	urrent r	ating (50	) = 50 A	)			
	3 -	E	ssential	part nu	mber				
	4 -	· V	Voltage rating (060 = 600 V)						
	5 -	S	Speed/type (W = Warp IGBT)						
	6 -	Circuit configuration (H = Half bridge)							
	7 -	T = Thermistor							
	8 -	A	$A = Al_2O_3$ substrate						
	9 -	L	Lead (Pb)-free						

#### **CIRCUIT CONFIGURATION**



LINKS TO RELATED DOCUMENTS								
Dimensions www.vishay.com/doc?95175								
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